

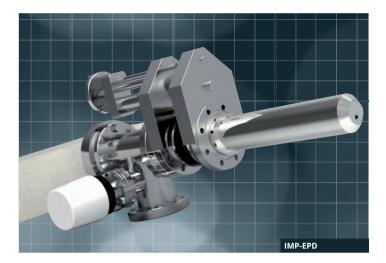
# Plasma Etch IN MICROTECHNOLOGY

Advanced Langmuir probe for plasma diagnostics

In-situ SIMS analysers for real-time etch monitoring at the nanoscale

> Vacuum process gas analysis / Residual gas analysis

High performance probe for mass and energy analysis of ions, radicals and neutrals from plasma



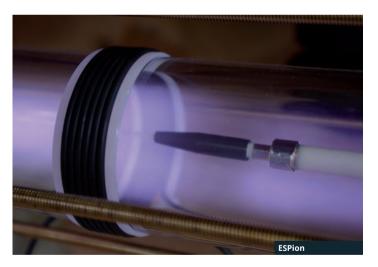
#### In-situ SIMS analysers for real-time etch monitoring at the nanoscale

- Hiden SIMS plasma and ion beam etch analysers provide a window on the entire etch process
- End point control to within +/- 5 Angstroms
- Integrated 'production ready' end point control is available



### High performance probe for mass and energy analysis of ions, radicals and neutrals from plasma

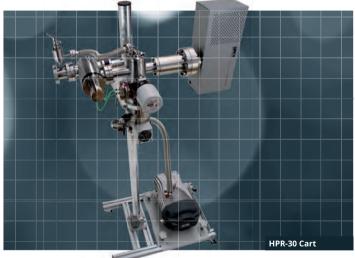
- +ve and -ve ion analysis
- Mass resolved ion energy analysis
- Neutrals and neutral radical analysis
- Energy resolved mass analysis
- Mass range options to 1000 amu
- Energy range options to 1000 eV



#### **Advanced Langmuir probe for** plasma diagnostics

- Floating Potential, V<sub>r</sub>
- Plasma Potential, V
- Electron Energy Distribution Function, EEDF
- Debye length,  $\lambda_{D}$
- lon Flux, Γ.

- Ion density, n., and electron density, n<sub>e</sub>, over the range 1014-1019 m-3
- Electron Temperature, T<sub>e</sub>, up to 10 eV
- Orbital Motion Limited (OML) and Allen Boyd Reynolds (ABR)



## Vacuum process gas analysis / **Residual gas analysis**

- Pump-down Profiles
- Backfill
- Vacuum Diagnostics
- Base Pressure
- Residuals

- Bakeout
- Leak Checking